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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/791,130	03/01/2004	David C. Newbury	H0782	2638

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EXAMINER

HOLLINGTON, JERMELE M

ART UNIT	PAPER NUMBER
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2829

DATE MAILED: 03/20/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

A

Office Action Summary	Application No. 10/791,130	Applicant(s) NEWBURY ET AL.	
	Examiner Jermele M. Hollington	Art Unit 2829	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 28 December 2005.
- 2a) ☒ This action is **FINAL**. 2b) ☐ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1-20 is/are pending in the application.
- 4a) Of the above claim(s) _____ is/are withdrawn from consideration.
- 5) ☐ Claim(s) _____ is/are allowed.
- 6) ☒ Claim(s) 1-20 is/are rejected.
- 7) ☐ Claim(s) _____ is/are objected to.
- 8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on _____ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some * c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
 2. ☐ Certified copies of the priority documents have been received in Application No. _____.
 3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- | | |
|--|---|
| 1) <input type="checkbox"/> Notice of References Cited (PTO-892) | 4) <input type="checkbox"/> Interview Summary (PTO-413)
Paper No(s)/Mail Date. _____ |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948) | 5) <input type="checkbox"/> Notice of Informal Patent Application (PTO-152) |
| 3) <input type="checkbox"/> Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)
Paper No(s)/Mail Date _____ | 6) <input type="checkbox"/> Other: _____ |

DETAILED ACTION

Claim Rejections - 35 USC § 102

1. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

2. Claims 1-3, 6-7, 10-13, 16-17 and 20 are rejected under 35 U.S.C. 102(e) as being anticipated by Cowan (6605951).

Regarding claim 1, Cowan disclose [see Figs. 1 and 3] a method for failure analysis of small contacts in integrated circuits (IC die 22), comprising: providing a plurality of opposing electrical contacts (bump contacts 62); and configuring the electrical contacts (62) to contact a sample (die 22) in an offset pattern such that any one electrical contact may contact more than one conductor in the sample and any opposing electrical contact (62) is offset-positioned to contact no more than one of the conductors contacted by the one electrical contact.

Regarding claim 2, Cowan disclose configuring the contacts (62) to be offset in two perpendicular lateral directions [via interconnectors 11 and 20 see Fig. 3].

Regarding claim 3, Cowan disclose the respective offsets in the two perpendicular lateral directions [via interconnectors 11 and 20] are unequal and vary from contact to contact.

Regarding claim 6, Cowan discloses [see Figs. 1 and 3] a method for failure analysis of small contacts in integrated circuits (IC die 22), comprising: providing a plurality of opposing electrical contact arrays (bump contacts 62); and configuring the electrical contact arrays (62) to

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contact a sample (22) in a pattern that is offset in two perpendicular lateral directions [via interconnectors 11 and 20] such that any one electrical contact in one of the contact arrays (62) may contact more than one conductor in the sample and any opposing electrical contact in an opposing contact array is offset- positioned to contact no more than one of the conductors contacted by the one electrical contact (62).

Regarding claim 7, Cowan discloses the respective offsets in the two perpendicular lateral directions [via interconnectors 11 and 20] are unequal and vary from contact to contact.

Regarding claim 10, Cowan discloses using the electrical contact arrays (62) for at least one of: periodically testing integrated circuits (22) during fabrication; and identifying at least one of the manufacturing equipment and the integrated circuits (22) present in an operating manufacturing process.

Regarding claim 11, Cowan disclose [see Figs. 1 and 3] a tester (tester 18) for failure analysis of small contacts in integrated circuits (IC die 22), comprising: a plurality of opposing electrical contacts (bump contacts 62); and means (interconnectors 11 and 20) for configuring the electrical contacts (62) to contact a sample in an offset pattern such that any one electrical contact (62) may contact more than one conductor in the sample (22) and any opposing electrical contact (62) is offset-positioned to contact no more than one of the conductors contacted by the one electrical contact (62).

Regarding claim 12, Cowan disclose the contacts (62) are offset in two perpendicular lateral directions [via interconnector 11 and 20].

Regarding claim 13, Cowan disclose the respective offsets in the two perpendicular lateral directions [via interconnectors 11 and 20] are unequal and vary from contact to contact.

Regarding claim 16, Cowan disclose a tester (tester 18) for failure analysis of small contacts in integrated circuits (IC die 22), comprising: a plurality of opposing electrical contact arrays (bump contacts 62); and means (interconnectors 11 and 20) for configuring the electrical contact arrays (62) to contact a sample (22) in a pattern that is offset in two perpendicular lateral directions such that any one electrical contact (62) in one of the contact arrays may contact more than one conductor in the sample and any opposing electrical contact (62) in an opposing contact array is offset-positioned to contact no more than one of the conductors contacted by the one electrical contact (62).

Regarding claim 17, Cowan disclose the respective offsets in the two perpendicular lateral directions [via interconnectors 11 and 20] are unequal and vary from contact to contact.

Regarding claim 20, Cowan discloses using the electrical contact arrays (62) for at least one of: periodically testing integrated circuits (22) during fabrication; and identifying at least one of the manufacturing equipment and the integrated circuits (22) present in an operating manufacturing process.

Claim Rejections - 35 USC § 103

3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

4. This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any

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evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

5. Claims 4-5, 8-9, 14-15 and 18-19 are rejected under 35 U.S.C. 103(a) as being unpatentable over Cowan (6605951) in view of Takao (6639417).

Regarding claims 4, 8, 14 and 18, Cowan disclose a tester (tester 18) for failure analysis of small contacts in integrated circuits (IC die 22), comprising: a plurality of opposing electrical contact arrays (bump contacts 62). However, he does not disclose a parametric test structure as claimed. Takao discloses [Fig. 6] a tester (tester 3) for failure analysis of small contacts in integrated circuits (IC wafer 2), comprising: a plurality of opposing electrical contact arrays (wafer prober 5) and a parametric test structure (parametric testing system 1) for testing the opposing contacts. Further, Takao teaches that the addition of parametric testing system is advantageous because it test wafers in the process for manufacturing semiconductor circuit devices [see col. 1, lines 8-13]. It would have been obvious to a person having ordinary skill in the art at the time the invention was made to modify the apparatus of Cowan by adding parametric test structure as taught by Takao in order to test wafers in the process for manufacturing semiconductor circuit devices.

Regarding claims 5, 9, 15 and 19, Cowan disclose a tester (tester 18) for failure analysis of small contacts in integrated circuits (IC die 22), comprising: a plurality of opposing electrical contact arrays (bump contacts 62). However, he does not disclose means for using the parametric test structure as claimed. Takao discloses [Fig. 6] a tester (tester 3) for failure analysis of small

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contacts in integrated circuits (IC wafer 2), comprising: a plurality of opposing electrical contact arrays (wafer prober 5), a parametric test structure (parametric testing system 1) for testing the opposing contacts and means (computer 6A) for using the parametric test structure (1) to adjust the offset pattern of the contacts (5). Further, Takao teaches that the addition of means for using parametric testing system is advantageous because it test wafers in the process for manufacturing semiconductor circuit devices and controls the tester while processing measured data [see col. 1, lines 8-13]. It would have been obvious to a person having ordinary skill in the art at the time the invention was made to modify the apparatus of Cowan by adding parametric test structure as taught by Takao in order to test wafers in the process for manufacturing semiconductor circuit devices and controls the tester while processing measured data.

Conclusion

6. Applicant's arguments filed Dec. 28, 2005 have been fully considered but they are not persuasive.

1) The applicants' argue: *"Regarding independent claims 1, 6, 11 and 16, the Applicants respectfully traverse the rejections of these claims since the Applicants' claimed combinations, as exemplified in claim 1, includes the limitation not disclosed in Cowan of: "providing a plurality of opposing electrical contacts". However, Cowan does not disclose opposing electrical contacts, but at column 5, lines 18-31, states: "A... bump contact 62 is mounted on the top surface 48... of the tape 46... The bump contact 62...attach[es] itself to...the die 22...as shown in Fig. 3.". Thus, as described and as shown in Fig. 3 while the tapes 46 may be considered to face one another and thus be "opposing", the bump contacts 62 both face in the same (upward) direction toward the die 22. The bump contacts are thus disposed parallel to one another, not opposing..."*

In response to the above argument, the examiner respectfully disagrees with the applicants. First, the claimed invention does not go in depth the position of "opposing electrical

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contacts.” With that in mind, the examiner was taking the position stated in MPEP 2111, which is to give pending claims the broadest reasonable interpretation. In Merriam Webster’s Collegiate® Dictionary 10th Edition, page 816, left column, it states that the word “opposing” means “1: to place opposite or against something 2: to place over against something so as to provide resistance, counterbalance, or contrast”. In viewing Cowan Figs. 1 and 3, the bump 62 is against the die 22. Therefore, one of ordinary skill would determine that bump 62 is opposing die 22. Therefore, the examiner believes the prior art still reads on the claimed invention.

2) The applicants further argue: *“The Applicants also respectfully traverse the rejections of claims 4, 8, 14 and 18 on the grounds that the Applicants’ claimed combinations would be patentable over Cowan in view of Takao since the Applicants’ claimed combinations, as exemplified in claim 4, includes the limitation not disclosed in Cowan or Takao of: “providing a parametric test structure for testing the opposing contacts” ... Takao does not teach or suggest “a plurality of opposing electrical contact arrays (wafer prober 5)”, but at column 1, lines 48-61 only discloses the wafer prober 5... Takao does not teach or suggest opposing electrical contact, and could not provide this teaching for a combination with Cowan. Further, Takao teaches and suggest nothing about “a parametric test structure (parametric testing system 1) for testing the opposing contacts”, as stated by the examiner. First, there is no disclosure or suggestion in Takao for “opposing contacts”, as just explained above, so there is no corresponding structure disclosed for testing any such undisclosed opposing contacts. Secondly, the “parametric testing system 1” of Takao is a system for testing the parameters of a semiconductor die, not for testing the contacts of a die tester, as explained in Takao column 1, lines 8-13...”*

In response to the above arguments, the examiner respectfully disagrees with the applicants. First, in response to applicant's arguments against the references individually, one cannot show nonobviousness by attacking references individually where the rejections are based on combinations of references. See *In re Keller*, 642 F.2d 413, 208 USPQ 871 (CCPA 1981); *In re Merck & Co.*, 800 F.2d 1091, 231 USPQ 375 (Fed. Cir. 1986). Second, in response to

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applicant's argument that Takao does not teach "opposing electrical contact", the test for obviousness is not whether the features of a secondary reference may be bodily incorporated into the structure of the primary reference; nor is it that the claimed invention must be expressly suggested in any one or all of the references. Rather, the test is what the combined teachings of the references would have suggested to those of ordinary skill in the art. See *In re Keller*, 642 F.2d 413, 208 USPQ 871 (CCPA 1981). The examiner does believe Takao disclose an opposing electrical contact. As stated above, the claimed invention does not go in depth the position of "opposing electrical contacts." With that in mind, the examiner was taking the position stated in MPEP 2111, which is to give pending claims the broadest reasonable interpretation. Takao discloses wafer under test 2 having plurality of dice 20 that includes modules 21 [col. 1, lines 49-53], wafer prober 5 that includes probe [col. 1, lines 22-24], and a parametric test structure 1 that includes the wafer prober 5, tester 3, and computer 6A [col. 1, lines 19-27]. The examiner uses the probe of the wafer prober 5 as the opposing electrical contact since it makes contact with the module 21 of the die 20 of the wafer 2 [see col. 1, lines 53-56]. Therefore, the examiner believes the prior art still reads on the claimed invention.

3) Lastly, the applicants further argue: *"The Applicants also respectfully traverse the rejections of claims 5, 9, 15 and 19 on the grounds that the Applicants' claimed combinations would be patentable over Cowan in view of Takao since the Applicants' claimed combinations, as exemplified in claim 5, includes the limitation not disclosed in Cowan or Takao of: "using the parametric test structure to adjust the offset pattern of the contacts"...Takao does not teach or suggest "means (computer 6A) for using the parametric test structure (1) to adjust the offset pattern of the contacts", but at column 1, lines 24-25...Takao does not teach or suggest using the parametric test structure to adjust the offset pattern of the contacts, and could not provide this teaching for a combination with Cowan.*

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In response to the above arguments, the examiner respectfully disagrees with the applicants. First, in response to applicant's arguments against the references individually, one cannot show nonobviousness by attacking references individually where the rejections are based on combinations of references. See *In re Keller*, 642 F.2d 413, 208 USPQ 871 (CCPA 1981); *In re Merck & Co.*, 800 F.2d 1091, 231 USPQ 375 (Fed. Cir. 1986). Second, in response to applicant's argument that Takao does not teach "opposing electrical contact", the test for obviousness is not whether the features of a secondary reference may be bodily incorporated into the structure of the primary reference; nor is it that the claimed invention must be expressly suggested in any one or all of the references. Rather, the test is what the combined teachings of the references would have suggested to those of ordinary skill in the art. See *In re Keller*, 642 F.2d 413, 208 USPQ 871 (CCPA 1981). Takao does disclose using parametric test structure to adjust the contacts (probe of wafer prober 5). In col. 1, lines 19-27, it states that the parametric test structure comprises wafer prober 5, tester 3, computer 6A and a measuring program group 6B. Since, as stated by the applicants, in "col. 1, lines 24-25, teaches: "a computer 6a for controlling the tester body 3 and wafer prober 5 and processing measured data"" it would be inherent that parametric test structure is being controlled. Therefore, the examiner believes the prior art still reads on the claimed invention.

Base on the above arguments, the following is being applied.

7. **THIS ACTION IS MADE FINAL.** Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO

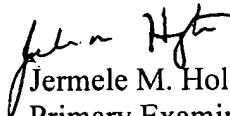
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MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Jermele M. Hollington whose telephone number is (571) 272-1960. The examiner can normally be reached on M-F (9:00-4:30 EST) First Friday Off.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy can be reached on (517) 272-1705. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).


Jermele M. Hollington
Primary Examiner
Art Unit 2829

JMH
March 16, 2006